### 504310498 04/06/2017

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4357180

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
LAKSHMINARAYANA PAPPU	04/05/2017

#### **RECEIVING PARTY DATA**

Name:	INTEL CORPORATION	
Street Address:	2200 MISSION COLLEGE BOULEVARD	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95054	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15475902

#### **CORRESPONDENCE DATA**

**Fax Number:** (503)439-6073

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Email:zoe\_bostwick@bstz.comCorrespondent Name:SPENCER HUNTER/BSTZAddress Line 1:1279 OAKMEAD PARKWAY

Address Line 4: SUNNYVALE, CALIFORNIA 94085-4040

ATTORNEY DOCKET NUMBER:	42P107188
NAME OF SUBMITTER:	SPENCER K. HUNTER
SIGNATURE:	/Spencer K. Hunter/
DATE SIGNED:	04/06/2017

## **Total Attachments: 2**

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PATENT 504310498 REEL: 041889 FRAME: 0690

Attorney's Docket No.: 42P107188

# **ASSIGNMENT**

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

#### Lakshminarayana Pappu

hereby sell, assign, and transfer to

#### **Intel Corporation**

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

SYSTEMS, METHODS, AND APPARATUSES FOR IMPLEMENTING TESTING OF A FAR MEMORY SUBSYSTEM WITHIN TWO-LEVEL MEMORY (2LM) STACKED DIE SUBSYSTEMS

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on	March 31, 2017	as
US Application Number	15/475,902	anc

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filled in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

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PATENT REEL: 041889 FRAME: 0691 covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

TORKERNA	04/05/20
Inventor 1: Lakshminarayana Pappu	Date Signed
Inventor 2:	Date Signed
Inventor 3:	Date Signed
Inventor 4:	Date Signed
Inventor 5:	Date Signed
Inventor 6:	Date Signed
Inventor 7:	Date Signed
Inventor 8:	Date Signed
Inventor 9:	Date Signed
Inventor 10:	Date Signed
Inventor 11:	Date Signed
Inventor 12:	Date Signed

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